

SFP+

ESPBxx92-3LCD20

10Gbps SFP+ Bi-Directional Transceiver, 20km Reach

Tx1270/Rx1330nm / Tx1330/Rx1270nm

- Supports 9.95Gb/s to 10.3Gb/s data rates
- Simplex LC Connector Bi-Directional SFP+ Optical Transceiver
- Single 3.3V Supply
- Up to 20KM on 9/125um SMF
- A:1270nm DFB Laser transmitter,1330nm receiver
- B:1330nm DFB Laser transmitter,1270nm receiver
- Compliant with IEEE 802.3ae 10GBASE-LR and 10GBASE-LW
- SFP+ MSA SFF-8431 Compliant
- Digital Diagnostic SFF-8472 Compliant
- RoHS compliant and Lead Free
- Operating case temperature:
- Standard: 0 ~ 70 °C



Applications

- 10GBASE-LR at 10.3125Gbps
- 10GBASE-LW at 9.953Gbps
- Other Optical Links

Standard

- SFP+ MSA Compliant
- SFF-8472 reversion 9.5 compliant
- IEEE802.3-2005 compliant
- Telcordia GR-468-CORE compliant
- FCC 47 CFR Part 15,Class B compliant
- FDA 21 CFR 1040.10 and 1040.11,class1 compliant
- RoHS compliant

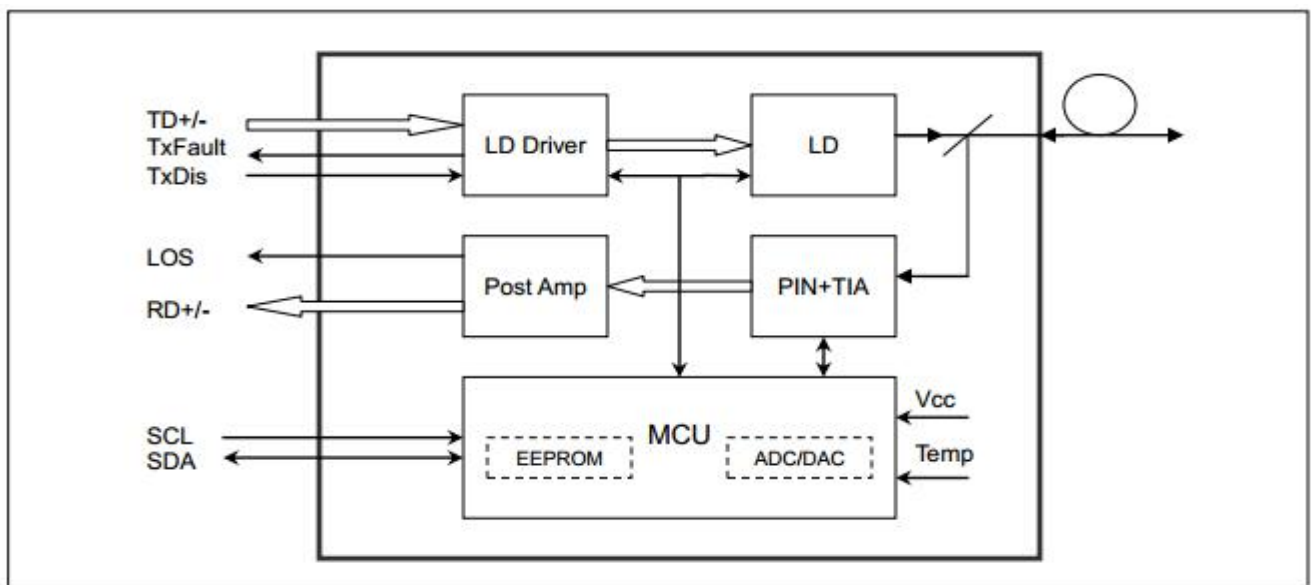
Product Description

The ESPBXX92-3LCD20 series single mode transceiver is a small form factor pluggable module for duplex optical data communications such as 10GBASE-LR/LW defined by IEEE 802.3ae. It is with the SFP+ 20-pin connector to allow hot plug capability.

The ESPBXX92-3LCD20 module is designed for single mode fiber and operates at a nominal wavelength of 1270nm or 1330nm; The transmitter section uses a multiple quantum well DFB, which is class 1 laser compliant according to International Safety Standard IEC-60825.

The receiver section uses an integrated InGaAs detector preamplifier (IDP) mounted in an optical header and a limiting post-amplifier IC.

Functional Diagram



Absolute Maximum Ratings

Parameter	Symbol	Min	Typ	Max	Unit	Ref.
Maximum Supply Voltage	Vcc	-0.5		4.7	V	
Storage Temperature	TS	-40		85	°C	
Case Operating Temperature	Tcase	-5		70	°C	

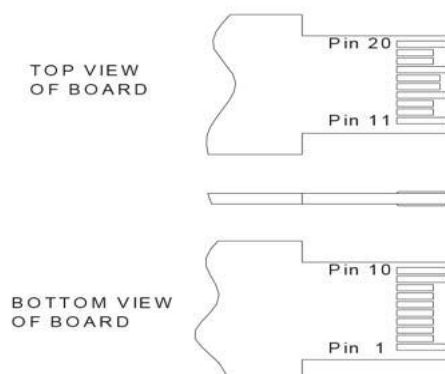
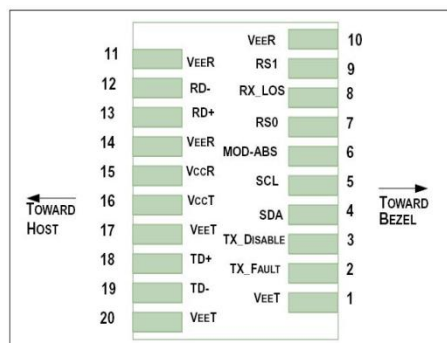
Optical Characteristics

Parameter	Symbol	Min	Typ	Max	Unit	Ref.
Transmitter						
Output Opt. Pwr	POUT	-2		2	dBm	1
Optical Wavelength	λ		1270/1330		nm	
Wavelength Temperature Dependence			0.08	0.125	nm/°C	
Spectral Width (-20dB)	σ			1	nm	
Optical Extinction Ratio	ER	3.5			dB	
Transmitter and Dispersion Penalty	TDP			3.2	dB	
Optical Rise/Fall Time	tr/ tf		0.1	0.26	ns	
RIN	RIN			-128	dB/Hz	
Output Eye Mask	Compliant with IEEE 0802.3ae					
Receiver						
Rx Sensitivity	RSENS			-14.4	dBm	2
Input Saturation Power (Overload)	Psat	-3			dBm	
Wavelength Range	λ_C		1330/1270		nm	
LOS De -Assert	LOSD			-16	dBm	
LOS Assert	LOSA	-30			dBm	
LOS Hysteresis		0.5	1.0		dB	

Note:

- 1) TD+/- are internally AC coupled with 100 Ω differential termination inside the module.
- 2) Tx Fault and Rx LOS are open collector outputs, which should be pulled up with 4.7k to 10k Ω resistors on the host board. Pullup voltage between 2.0V and Vcc+0.3V.
- 3) RD+/- outputs are internally AC coupled, and should be terminated with 100 Ω (differential) at the user SERDES.

Pin Assignment



Pin out of Connector Block on Host Board

Pin	Symbol	Name/Description	Ref.
1	VEET	Transmitter Ground (Common with Receiver Ground)	1
2	TFAULT	Transmitter Fault.	2
3	TDIS	Transmitter Disable. Laser output disabled on high or open.	3
4	SDA	2-wire Serial Interface Data Line	4
5	SCL	2-wire Serial Interface Clock Line	4
6	MOD_ABS	Module Absent. Grounded within the module	4
7	RS0	Rate Select 0	5
8	LOS	Loss of Signal indication. Logic 0 indicates normal operation.	6
9	RS1	No connection required	1
10	VEER	Receiver Ground (Common with Transmitter Ground)	1
11	VEER	Receiver Ground (Common with Transmitter Ground)	1
12	RD-	Receiver Inverted DATA out. AC Coupled	
13	RD+	Receiver Non-inverted DATA out. AC Coupled	
14	VEER	Receiver Ground (Common with Transmitter Ground)	1
15	VCCR	Receiver Power Supply	
16	VCCT	Transmitter Power Supply	
17	VEET	Transmitter Ground (Common with Receiver Ground)	1
18	TD+	Transmitter Non-Inverted DATA in. AC Coupled.	
19	TD-	Transmitter Inverted DATA in. AC Coupled.	
20	VEET	Transmitter Ground (Common with Receiver Ground)	1

Notes:

- 1) Circuit ground is internally isolated from chassis ground.
- 2) TFAULT is an open collector/drain output, which should be pulled up with a 4.7k – 10k Ohms resistor on the host board if intended for use. Pull up voltage should be between 2.0V to Vcc + 0.3V. A high output indicates a transmitter fault caused by either the TX bias current or the TX output power exceeding the preset alarm thresholds. A low output indicates normal operation. In the low state, the output is pulled to <0.8V.
- 3) Laser output disabled on TDIS>2.0V or open, enabled on TDIS<0.8V.

- 4) Should be pulled up with 4.7kΩ- 10kΩ host board to a voltage between 2.0V and 3.6V. MOD_ABS pulls line low to indicate module is plugged in.
- 5) Internally pulled down per SFF-8431 Rev 4.1.
- 6) LOS is open collector output. It should be pulled up with 4.7kΩ – 10kΩ on host board to a voltage between 2.0V and 3.6V. Logic 0 indicates normal operation; logic 1 indicates loss of signal.

Electrical Interface Characteristics

Parameter	Symbol	Min	Typ	Max	Unit	Ref.
Supply Voltage	Vcc	3.14	3.3	3.46	V	
Supply Current	Icc			300	mA	
Transmitter						
Input differential impedance	Rin		100		Ω	1
Single ended data input swing	Vin,pp	180		700	mV	
Transmit Disable Voltage	VD	Vcc–1.3		Vcc	V	
Transmit Enable Voltage	VEN	Vee		Vee+ 0.8	V	2
Transmit Disable Assert Time				10	us	
Receiver						
Differential data output swing	Vout,pp	300		850	mV	3
Data output rise time	tr	28			ps	4
Data output fall time	tf	28			ps	4
LOS Fault	VLOS fault	Vcc–1.3		VccHOST	V	5
LOS Normal	VLOS norm	Vee		Vee+0.8	V	5
Power Supply Rejection	PSR	100			mVpp	6

Notes:

- 1) Connected directly to TX data input pins. AC coupled thereafter.
- 2) Or open circuit.
- 3) Into 100 ohms differential termination.
- 4) 20 – 80 %.
- 5) Loss Of Signal is LVTTTL. Logic 0 indicates normal operation; logic 1 indicates no signal detected.
- 6) Receiver sensitivity is compliant with power supply sinusoidal modulation of 20 Hz to 1.5 MHz up to specified value applied through the recommended power supply filtering network.

SFP+ Module Control and Management

The SFP modules implement the 2-wire serial communication protocol as defined in the SFP MSA. The serial ID information of the SFP modules and Digital Diagnostic Monitor parameters can be accessed through the I2C interface at address A0h and A2h. The memory is mapped in Table

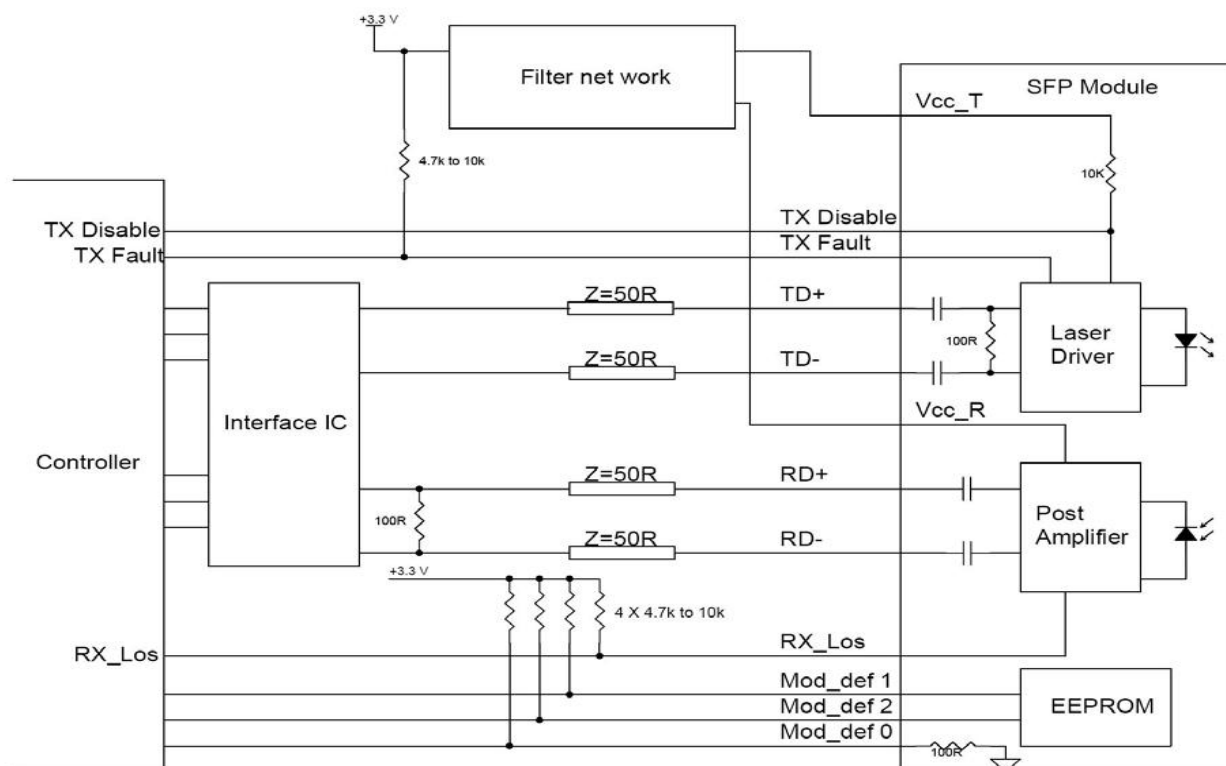
1. Detailed ID information(A0h) is listed in Table
2. And the DDM specification (A2h) is described in Table 3. For more details of the memory map and byte definitions please refer to the SFF-8472 (Rev 9.3, Aug. 2002), "Digital Diagnostic Monitoring Interface for Optical Transceivers".

2 wire address 1010000X (A0h)		2 wire address 1010001X (A2h)	
Address	Information	Address	Information
0~95	Serial ID Defined by SFP MSA (96 bytes)	0~55	Alarm and Warning Thresholds (56 bytes)
96~127	Vendor Specific (32 bytes)	56~95	Calibration Constants (40 bytes)
128~255	Reserved, SFF8079 (128 bytes)	96~119	Real Time Diagnostic Interface (24 bytes)
		120~127	Vender Specific (8 bytes)
128~255	Reserved, SFF8079 (128 bytes)	128~247	User Writable EEPROM (120 bytes)
		248~255	Vender Specific (8 bytes)

Table 2- DDM Specification

Parameter	Range	Accuracy	Calibration
Temperature	-10 ~ +80°C	±3°C	Internal
Voltage	3.0 ~ 3.6V	±3%	Internal
Bias Current	0 ~ 85mA	±10%	Internal
TX Power	-5 ~ 3dBm	±2dB	Internal
RX Power	-15 ~ 0dBm	±2dB	Internal

Typical Interface Circuit



General Operating Characteristics

Parameter		Symbol	Min	Typ	Max	Unit	Ref.
Data Rate	10G Base-LR			10.3125		Gb/s	
	10G Base-LW			9.953			
Supply Voltage		Vcc	3.13	3.3	3.5	v	
Supply Current		Icc			280	mA	
Operating case temperature		Tc	0		70	°C	

Regulatory Compliance

Feature	Reference	Performance
Electrostatic discharge (ESD)	IEC/EN 61000-4-2	Compatible with standards
Electromagnetic Interference (EMI)	FCC Part 15 Class B EN 55022 Class B (CISPR 22A)	Compatible with standards
Laser Eye Safety	FDA 21CFR 1040.10, 1040.11 IEC/EN 60825-1, 2	Class 1 laser product
Component Recognition	IEC/EN 60950, UL	Compatible with standards
ROHS	2002/95/EC	Compatible with standards
EMC	EN61000-3	Compatible with standards

Compatibility Test

In order to ensure the product compatibility, our products will be tested on the switch before shipment. Our modules can compatible with many mainstream brand switches, such as Cisco, Juniper, Extreme, Brocade, IBM, H3C, HP, Huawei, D-Link, Mikrotik, ZTE, TP-Link...

Our test equipment: VOLKTEK MEN-4110, HP 2530-8G, CRS226-24G-25+RM, Catalyst 2960G Series, Catalyst 3850 XS 10G SFP+, Catalyst 3750-E Series, HUAWEI S5700Series, H3C S3100V2 Series, Juniper-EX4200, etc.



Cisco Catalyst 3850



HUAWEI S5700



H3C S3100V2



HP J9264AR



Juniper EX 4200



Alcatel 6850E-U24X



Mikrotik CR5226-24G-25+RM



Cisco Catalyst 2960G



Volktek MEN-4110

Product Production Process

Quality Assurance

Continuous introduction of new equipment, produced by strict standards, strict quality inspection, to guarantee the high quality standard of each product.



**Standardized
Production Line**



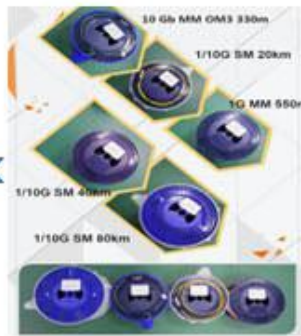
**Professional
Welding**



Assembling



Aging Testing



Distance Testing



Cleaning end face



Product Initial Test



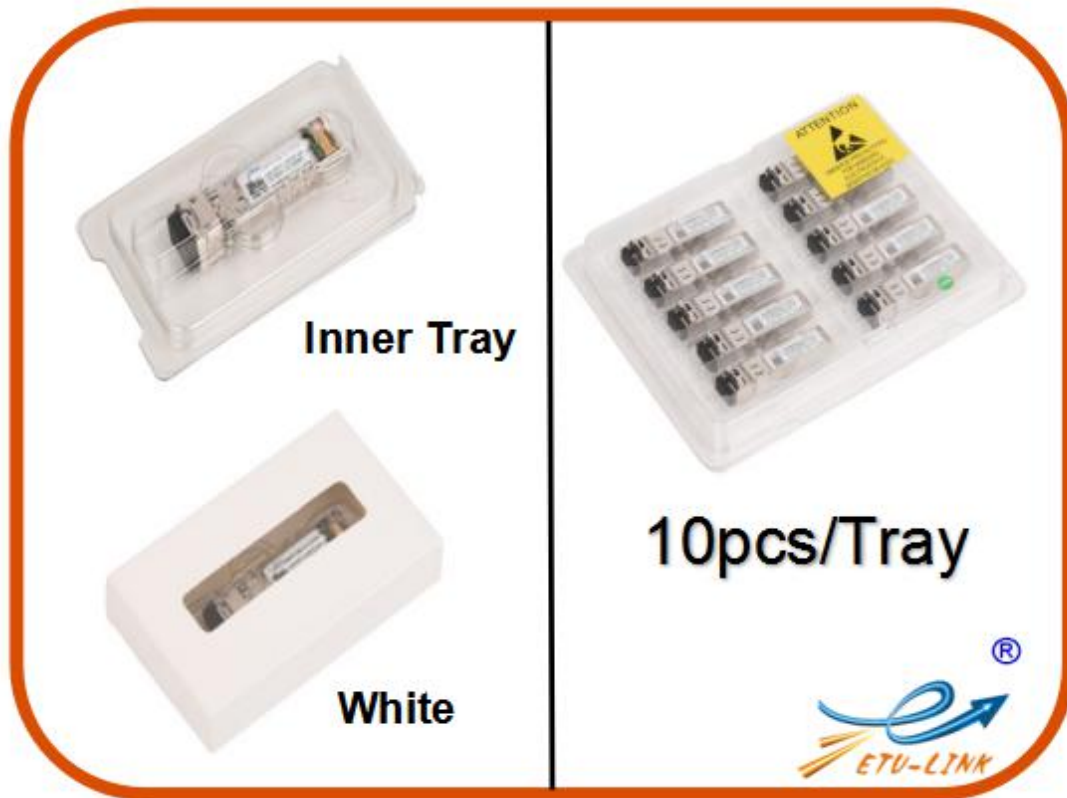
Switch Testing



Product Final Test

Packaging

ETU-Link provides two kinds of packaging, 10pcs/Tray and individual package.



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